

MAX20808 Evaluation Kit

General Description

The MAX20808 evaluation kit (EV kit) is a reference platform designed for the evaluation of the MAX20808/MAX20808T dual-output, compact, low-cost, fully integrated, highly efficient, step-down DC-DC switching regulator ICs. The ICs are packaged in 21-pin, 3.5mm x 4.6mm, 0.5mm pitch, FC2QFN.

This EV kit can deliver up to 4A load per output. For the MAX20808, the two outputs can be connected as a single-output, dual-phase regulator that supports up to 8A load current. Refer to the MAX20808 IC data sheet for more information.

The EV kit comprises a fully assembled and tested PCB implementation of the MAX20808/MAX20808T. Jumper pins, test points, and input/output connectors are included for flexibility and convenience in a wide range of applications.

Benefits and Features

- 2.7V to 16V Input Voltage Range
- 0.5V to 5.8V Output Voltage Range
- High Efficiency and Power Density
- Low Component Count
- Dual-Output (MAX20808/MAX20808T) or Single-Output Dual-Phase Operation (MAX20808)
- Optimized Performance
- Proven PCB Layout
- Fully Assembled and Tested

Quick Start

Required Equipment

- MAX20808 EV kit
- 2.7V to 16V power supply with optional 3.3V external power supply
- 0 to 8A load
- Digital voltmeters
- Oscilloscope and probes

Procedure

The EV kit is fully assembled and tested. The EV kit is preset with the MAX20808/MAX20808T dual-output operation with 1V on rail 1 and 1.8V on rail 2. Follow the steps below to verify board operation.

For dual-output operation (MAX20808/MAX20808T):

- Connect a powered-off 2.7V to 16V input supply to J5 (positive terminal) and J8 (negative terminal). Optionally, connect supply sense leads to TP5 (positive sense) and TP6 (negative sense) for best accuracy. If external bias is preferred, connect a powered-off 3.3V power supply to J32 (positive terminal) and J33 (negative terminal) with jumper J34 installed.
- 2. Connect the load to edge connector J12 for rail 1 or J13 for rail 2 (positive on top and negative on bottom).
- 3. Connect the VOUT scope probe/voltmeter to J2 for rail 1 or J3 for rail 2.
- 4. Turn on the power supply.
- 5. Position the SW1 or SW2 toggle switch to enable the IC.
- 6. Observe that VOUT1 = 1V and VOUT2 = 1.8V.
- 7. For efficiency measurements, TP5 and TP6 are used to measure VIN; J2 and J3 are used to measure VOUT1 and VOUT2.

For dual-phase operation (MAX20808 only):

- When configured to dual-phase operation, only the control loop for rail 1 works and the control loop for rail 2 is bypassed. The EN1 and PGOOD1 are used in dualphase operation mode to enable the device and indicate power-good status. The EN2 and PGOOD2 can be disconnected.
- 2. Install 0Ω resistor for R2, R44, R45, and R48 to short two rail outputs.
- 3. Remove R13 for rail 2 to disconnect the sense line and install 0Ω in R34 to pull SNSP2 to AVDD.
- 4. Use the same inductors for L1 and L2.
- 5. Connect a powered-off 2.7V to 16V input supply to J5 (positive terminal) and J8 (negative terminal). Optionally, connect supply sense leads to TP5 (positive sense) and TP6 (negative sense) for best accuracy. If external bias is preferred, connect a powered-off 3.3V power supply to J32 (positive terminal) and J33 (negative terminal) with jumper J34 installed.
- 6. Connect the load to edge connector J12 (positive on top and negative on bottom).
- 7. Connect the VOUT scope probe/voltmeter to J2 or J3.
- 8. Turn on the power supply.
- 9. Position the SW1 toggle switch to enable the IC.
- 10. Observe that VOUT = 1V.
- 11. For efficiency measurements, TP5 and TP6 are used to measure VIN; J2 or J3 is used to measure VOUT.

319-100743; Rev 1; 2/24

MAX20808 EV Kit Board

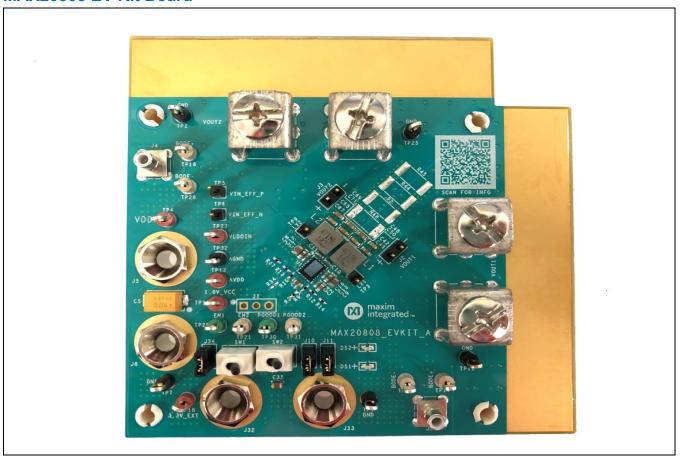


Table 1. Jumper Connection Guide

JUMPER	DEFAULT CONNECTION	FEATURE
J10	INSTALLED	Installed for EN2
J11	INSTALLED	Installed for PGOOD2
J34	INSTALLED	Installed for external 3.3V input

Default options are bold.

Operation

The MAX20808/MAX20808T ICs are monolithic, dual-output high-frequency step-down switching regulators optimized for applications requiring small size and high efficiency. Detailed product and application information is provided in the MAX20808 IC data sheet.

Output Enable (OE)

The OE is used to enable/disable the output voltage. For dual-output operation (MAX20808/MAX20808T), rail 1 output voltage is enabled/disabled by SW1 and rail 2 output voltage is enabled/disabled by SW2. For single-output dual-phase operation (MAX20808), EN1 is used and EN2 can be disconnected.

Output-Voltage Selection

The MAX20808 EV kit is set up to initially boot up to an output voltage of 1V of rail 1 and 1.8V of rail 2. The device has a fixed 0.5V reference voltage, and the output voltage is accomplished by placing a voltage divider in the feedback path.

$$V_{OUT} = V_{REF} \times (1 + R_{FB1}/R_{FB2})$$

where

V_{OUT} = Output voltage

 V_{REF} = 0.5V fixed reference voltage

 R_{FB1} = Top divider resistor

R_{FB2} = Bottom divider resistor

Soft-Start

When VDDH and EN are above their rising thresholds, the soft-start begins, and switching is enabled. The soft-start ramp time is 3ms. The device supports smooth startup with output prebiased.

Switching Frequency

Switching frequency is programmable parameters and PGM0 is used to select the switching frequency. For the EV kit, switching frequency is set to 1000kHz for rail 1 and 2000kHz for rail 2. Refer to PGM0 Configurations table (Table 1) in the MAX20808 IC data sheet.

Pin-Strap Programmability

The MAX20808 EV kit provides an option to configure the part for desired application using PGMx resistor values. Refer to Table 1 through Table 3 in the MAX20808 IC data sheet. Appropriate values of resistors R11, R21, and R35 can be used for the desired application.

Status Monitoring

Whenever the part is actively regulating, and the output voltage is within the power-good window, the PGOOD pin is high. In all other conditions, including enabled but in a fault state, the PGOOD pin is pulled low. Refer to the MAX20808 IC data sheet for more details.

Input-Voltage Monitoring

The input supply can be monitored on TP4 for VDDH and TP7 for GND.

Switching-Voltage Monitoring

The switching waveform can be monitored on TP3 for LX1 and TP9 for LX2.

Output-Voltage Monitoring

Jumpers J2 and J3 monitor the output voltage of rail 1 and rail 2, respectively. These test points should not be used for loading.

Efficiency Testing

The TP5 (VIN_EFF_P) and TP6 (VIN_EFF_N) test points are provided to measure VIN during efficiency measurement. Additionally, J2 and J3 are provided to measure VOUT1 and VOUT2 during efficiency measurement.

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Bode Plot

A 10Ω resistor is installed between the VOUTx sense point and SNSPx pin to measure the Bode plot. The TP13 and TP14 test points are provided on the board on either side of the 10Ω resistor for small signal injection and the ability to measure a Bode plot for VOUT1. The TP28 and TP16 test points are provided on the board on either side of the 10Ω resistor for small signal injection and the ability to measure a Bode plot for VOUT2.

Ordering Information

PART	TYPE
MAX20808EVKIT#	EV Kit
MAX20808TEVKIT#	EV Kit

#Denotes RoHS compliance.

MAX20808 EV Kit Bill of Materials

ITEM	REF_DES	DNI/DNP	QTY	MFG PART#	MANUFACTURER	VALUE	DESCRIPTION
1	C2	_	1	C1608X5R1E475K080AC; GRM188R61E475KE11	TDK; MURATA	4.7UF	CAPACITOR; SMT (0603); CERAMIC CHIP; 4.7UF; 25V; TOL=10%; TG=-55 DEGC TO +85 DEGC; TC=X5R
2	C3, C5, C34	_	3	TPSD107K020R0085	AVX	100UF	CAPACITOR; SMT; 7343; TANTALUM; 100uF; 20V; 10%; TPS; -55degC to +125degC
3	C4, C7, C16, C31	l	4	GRM155R71E104ME14	MURATA	0.1UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 0.1UF; 25V; TOL=20%; TG=-55 DEGC TO +125 DEGC; TC=X7R
4	C6, C12, C13	I	3	GRM188R71E105KA12; CGA3E1X7R1E105K; TMK107B7105KA; 06033C105KAT2A; GCM188R71E105KA64; C1608X7R1E105K080AE; CGA3E1X7R1E105K080AC	MURATA; TDK; TAIYO YUDEN; AVX; MURATA; TAIYO YUDEN; TDK	1UF	CAPACITOR; SMT (0603); CERAMIC CHIP; 1UF; 25V; TOL=10%; TG=-55 DEGC TO +125 DEGC; TC=X7R
5	C8, C9		2	GRM21BC71E106KE11	MURATA	10UF	CAPACITOR; SMT (0805); CERAMIC CHIP; 10UF; 25V; TOL=10%; TG=-55 DEGC TO +125 DEGC; TC=X7S
6	C10, C11	_	2	CL05B224KP5NNN	SAMSUNG ELECTRONICS	0.22UF	CAPACITOR; SMT (0402); CERAMIC CHIP; 0.22UF; 10V; TOL=10%; TG=-55 DEGC TO +125 DEGC; TC=X7R
7	C26, C30	_	2	C0402C102K5GAC	KEMET	1000PF	CAPACITOR; SMT (0402); CERAMIC CHIP; 1000PF; 50V; TOL=10%; MODEL=; TG=-55 DEGC TO +125 DEGC; TC=C0G
8	C27	П	1	GRM188Z71C225KE43	MURATA	2.2UF	CAPACITOR; SMT (0603); CERAMIC CHIP; 2.2UF; 16V; TOL=10%; TG=-55 DEGC TO +125 DEGC; TC=X7R
9	C29, C45	_	2	C0402C101J5GAC; NMC0402NPO101J; CC0402JRNPO9BN101; GRM1555C1H101JA01; C1005C0G1H101J050BA; CGA2B2C0G1H101J050BA	KEMET; NIC COMPONENTS CORP.; YAGEO PHICOMP; MURATA;TDK;TDK	100PF	CAPACITOR; SMT (0402); CERAMIC CHIP; 100PF; 50V; TOL=5%; TG=-55 DEGC TO +125 DEGC; TC=C0G
10	C35	_	1	GRM21BZ70J226ME44	MURATA	22UF	CAP;SMT (0805);22UF; 20%; 6.3V; X7R; CERAMIC CHIP; NOTE: PURCHASE DIRECT FROM THE MANUFACTURER
11	C32, C36, C37, C39, C42, C46, C48, C50, C60, C63, C65, C67, C69, C71	_	14	GRM188C80J226ME15	MURATA	22UF	CAP; SMT (0603); 22UF; 20%; 6.3V; X6S; CERAMIC CHIP

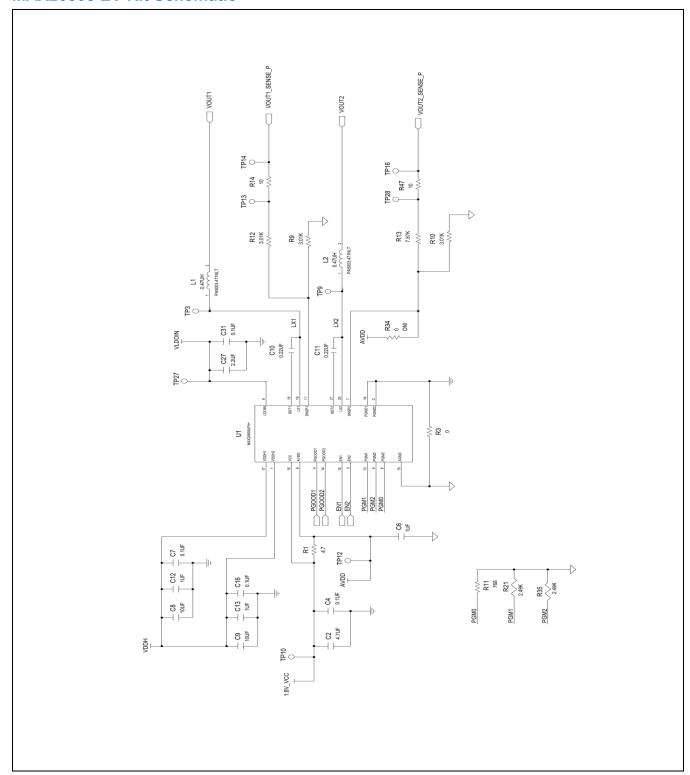
ITEM	REF_DES	DNI/DNP	QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
12	C47, C61	_	2	GRM155R71E104KE14; C1005X7R1E104K050BB; TMK105B7104KVH; CGJ2B3X7R1E104K050BB	MURATA;TDK;TAIYO YUDEN;TDK	0.1UF	MURATA;TDK;TAIYO YUDEN;TDK
13	D1, D3, D4	_	3	MBRS540T3G	ON SEMICONDUCTOR	MBRS540T3	DIODE; SCH; SURFACE MOUNT SCHOTTKY POWER RECTIFIER; SMC; PIV=40V; IF=5A
14	DS1, DS2	_	2	LGL29K-G2J1-24-Z	OSRAM	LGL29K- G2J1-24-Z	DIODE; LED; SMARTLED; GREEN; SMT; PIV=1.7V; IF=0.02A
15	J2, J3, J10, J11, J34	_	5	TSW-101-22-L-D	SAMTEC	TSW-101- 22-L-D	CONNECTOR; MALE; THROUGH HOLE; .025IN SQ POST HEADER; STRAIGHT; 2PINS
16	J4, J9	Ι	2	131-3701-266	JOHNSON COMPONENTS	131-3701- 266	CONNECTOR; MALE; THROUGH HOLE; SMB JACK VERTICAL PCB MOUNT; STRAIGHT; 5PINS
17	J5, J8, J32, J33	l	4	6095	KEYSTONE	6095	CONNECTOR; FEMALE; PANELMOUNT; NON- INSULATED RECESSED HEAD BANANA JACK; STRAIGHT THROUGH; 1PIN
18	L1, L2	_	2	PA5003.471NLT	PULSE	0.47UH	INDUCTOR; SMT; COMPOSITE; 0.47UH; 20%; 18.4A
19	MH1-MH4	_	4	9032	KEYSTONE	9032	MACHINE FABRICATED; ROUND-THRU HOLE SPACER; NO THREAD; M3.5; 5/8IN; NYLON
20	Q1, Q2	-	2	BSS138	ON SEMICONDUCTOR	BSS138	TRAN; LOGIC LEVEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR; NCH; SOT-23; PD-(0.36W); I-(0.22A); V-(50V); -55 DEGC TO +150 DEGC
21	R1	-	1	CRCW04024R70FK	VISHAY DALE	4.7	RESISTOR, 0402, 4.7 OHM, 1%, 100PPM, 0.0625W, THICK FILM
22	R3	-	1	RC0402JR-070RL; CR0402-16W-000RJT	YAGEO PHYCOMP; VENKEL LTD	0	RESISTOR; 0402; 0 OHM; 5%; JUMPER: 0.063W; THICK FILM
23	R9, R10, R12	-	3	CRCW04023K01FK	VISHAY DALE	3.01K	RESISTOR; 0402; 3.01 K OHM; 1%; 100PPM; 0.063W; THICK FILM
24	R11	-	1	ERJ-2RKF7680	PANASONIC	768	RES; SMT (0402); 768; 1%; +/- 100PPM/DEGC; 0.1W
25	R13	-	1	ERJ-2RKF7871	PANASONIC	7.87K	RES; SMT (0402); 7.87K; 1%; +/-100PPM/DEGK; 0.1W
26	R14, R47	-	2	CRCW040210R0FK; 9C04021A10R0FL	VISHAY DALE; YAGEO	10	RESISTOR; 0402; 10 OHM; 1%; 100PPM; 0.0625W; THICK FILM

ITEM	REF_DES	DNI/DNP	QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
27	R25, R26	-	2	CRCW040249R9FKEDHP	VISHAY DRALORIC	49.9	RESISTOR; 0402; 49.9 OHM; 1%; 100PPM; 0.2W; THICK FILM
28	R21, R35	-	2	ERJ-2RKF2491	PANASONIC	2.49K	RESISTOR; 0402; 2.49K OHM; 1%; 100PPM; 0.10W; THICK FILM
29	R39, R40	-	2	ERJ-2RKF1002	PANASONIC	10K	RESISTOR; 0402; 10K OHM; 1%; 100PPM; 0.10W; THICK FILM
30	R41, R52	-	2	CRCW040220K0FK	VISHAY DALE	20K	RESISTOR; 0402; 20K OHM; 1%; 100PPM; 0.063W; THICK FILM
31	R42, R53	-	2	CRCW0603100RFK; ERJ-3EKF1000; RC0603FR-07100RL	VISHAY DALE; PANASONIC	100	RESISTOR; 0603; 100 OHM; 1%; 100PPM; 0.10W; THICK FILM
32	R51, R54	-	2	ERJ-3EKF2100	PANASONIC	210	RESISTOR; 0603; 210 OHM; 1%; 100PPM; 0.10W; THICK FILM
33	ST1-ST4	-	4	7808	KEYSTONE	7808	TERMINAL; BODY LENGTH=0.67IN; BODY WIDTH=0.47IN; HEIGHT=0.45IN; SCRW; BRASS
34	SU1-SU3	-	3	S1100-B; SX1100-B; STC02SYAN	KYCON; KYCON; SULLINS ELECTRONICS CORP	SX1100-B	TEST POINT; JUMPER; STR; TOTAL LENGTH=0.24IN; BLACK; INSULATION=PBT;PHOSPHO R BRONZE CONTACT=GOLD PLATED
35	SW1, SW2	-	2	GT21MCBE	C&K COMPONENTS	GT21MCBE	SWITCH; DPDT; THROUGH HOLE; 20V; 0.4VA; GT SERIES; SEALED ULTRAMINIATURE TOGGLE SWITCH; RCOIL= 0.05 OHM; RINSULATION=10G OHM; C&K COMPONENTS
36	TP1, TP2, TP7, TP11, TP25, TP32	-	6	5011	KEYSTONE	N/A	TEST POINT; PIN DIA=0.125IN; TOTAL LENGTH=0.445IN; BOARD HOLE=0.063IN; BLACK; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH; RECOMMENDED FOR BOARD THICKNESS=0.062IN; NOT FOR COLD TEST
37	TP3, TP5, TP6, TP9	-	4	PBC01SAAN	SULLINS ELECTRONICS CORP	PBC01SAAN	CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT; 1PIN
38	TP4, TP10, TP12, TP18, TP27	-	5	5010	KEYSTONE	N/A	TEST POINT; PIN DIA=0.125IN; TOTAL LENGTH=0.445IN; BOARD HOLE=0.063IN; RED;

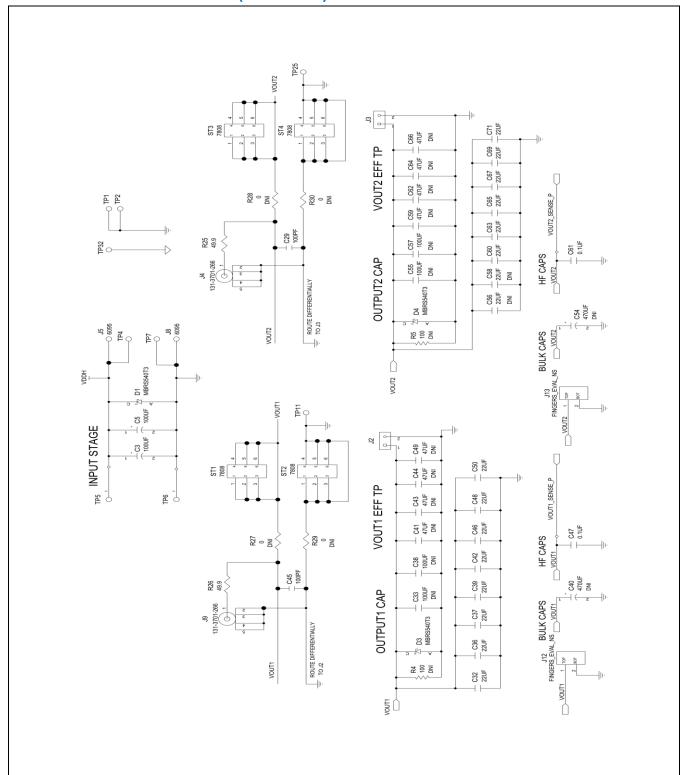
ITEM	REF_DES	DNI/DNP	QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
							PHOSPHOR BRONZE WIRE
							SIL; NOT FOR COLD TEST
							TEST POINT; PIN
							DIA=0.125IN; TOTAL
	TP13,						LENGTH=0.445IN; BOARD
	TP14,						HOLE=0.063IN; WHITE;
39	TP16,	_	6	5012	KEYSTONE	N/A	PHOSPHOR BRONZE WIRE
	TP21,						SILVER PLATE FINISH;
	TP28, TP31						RECOMMENDED FOR
							BOARD THICKNESS=0.062IN;
							NOT FOR COLD TEST
							TEST POINT; PIN
							DIA=0.125IN; TOTAL
							LENGTH=0.445IN; BOARD
							HOLE=0.063IN; GREEN;
40	TP29, TP30	_	2	5126	KEYSTONE	N/A	PHOSPHOR BRONZE WIRE
							SILVER PLATE FINISH;
							RECOMMENDED FOR
							BOARD THICKNESS=0.062IN;
							NOT FOR COLD TEST
							EVKIT PART - IC;
							MAX20808AFH+/
							MAX20808TAFH+; DUAL-
							OUTPUT 4A; 3MHZ; 2.7V - 16V
							STEP-DOWN SWITCHING
41	U1	-	1	MAX20808AFH+/	ANALOG DEVICES	MAX20808/	REGULATOR; PACKAGE
				MAX20808TAFH+		MAX20808T	OUTLINE DRAWING
							NUMBER: 21-100394/21-
							100513; LAND PATTERN: 90-
							100134/90-100184; PACKAGE
							CODE: F213A4F+1/
							F213A4F+2; FC2QFN21
42	PCB	_	1	MAX20808	ANALOG DEVICES	PCB	PCB:MAX20808
43	C56, C58	DNP	2	GRM188C80J226ME15	MURATA	22UF	CAP; SMT (0603); 22UF; 20%;
							6.3V; X6S; CERAMIC CHIP
l	C33, C38,						CAP; SMT (1206); 100UF;
44	C55, C57	DNP	4	GRM31CD80J107ME39	MURATA	100UF	20%; 6.3V; X6T; CERAMIC
							CHIP
							CAPACITOR; SMT (7343);
45	C40, C54	DNP	2	T491X477K010AT	KEMET	470UF	TANTALUM CHIP; 470UF; 10V;
							TOL=10%; MODEL=T491
-	044 040						SERIES
	C41, C43, C44, C49,			C0805C476M9PAC;			CAPACITOR; SMT (0805);
46		DNP	8	,	KEMET; MURATA	47UF	CERAMIC CHIP; 47UF; 6.3V;
	C59, C62,			GRM21BR60J476ME15			TOL=20%; TG=-55 DEGC TO
	C64, C66			CRCW04020000Z0EDHP;	VISHAY DRALORIC;		+85 DEGC; TC=X5R
47	R27-R30	DNP	4	RCS04020000Z0EDHP;	•	0	RESISTOR; 0402; 0 OHM; 0%;
				NO30402000020	VISHAY DALE		JUMPER; 0.2W; THICK FILM
40	D4 D5	חאם	DNP 2	ED I D00 1404	DANIACONIC	100	RESISTOR; 1206; 100 OHM;
48	R4, R5	DNP		ERJ-P08J101	PANASONIC		5%; 200PPM; 0.66W; THICK
				DC0403 ID 070DL .	VACEO DUVCOMP		FILM
49	R34	DNP	1	RC0402JR-070RL;	YAGEO PHYCOMP;	0	RESISTOR; 0402; 0 OHM; 5%;
			l	CR0402-16W-000RJT	VENKEL LTD		JUMPER; 0.063W; THICK FILM

ITEM	REF_DES	DNI/DNP	QTY	MFG PART #	MANUFACTURER	VALUE	DESCRIPTION
50	R2, R44,	DND	١,	CRCW25120000ZS	VISHAY DALE	0	RESISTOR; 2512; 0 OHM; 1%;
50	R45, R48	DNP	4	CRCW2512000025	VISHAT DALE		JUMPER; 1.0W; METAL FILM
				CONNECTOR; MALE;			
E4	14	DNP	4	PEC03SAAN	SULLINS	PEC03SAAN	THROUGH HOLE;
51	J1	DINP	'	PECUSSAAN	SULLINS		BREAKAWAY; STRAIGHT;
							3PINS

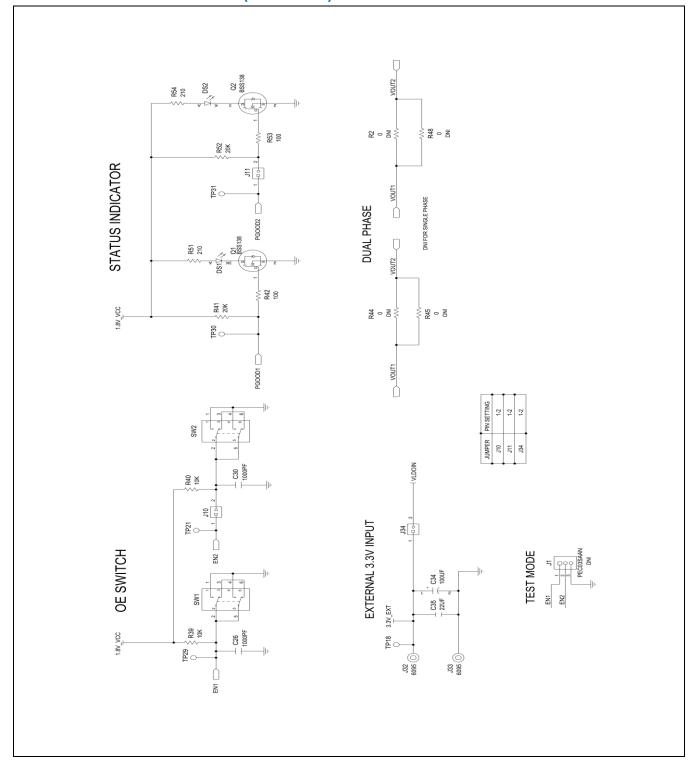
MAX20808 EV Kit Schematic



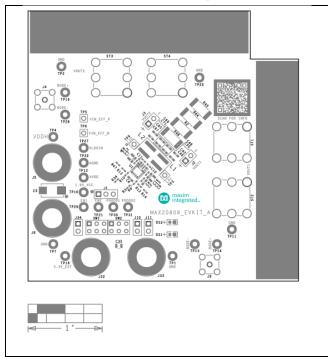
MAX20808 EV Kit Schematic (continued)



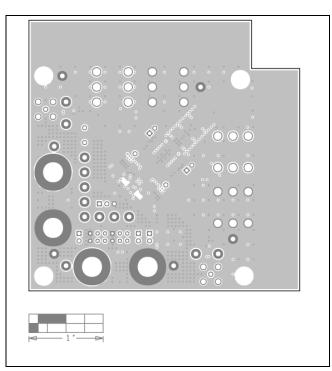
MAX20808 EV Kit Schematic (continued)



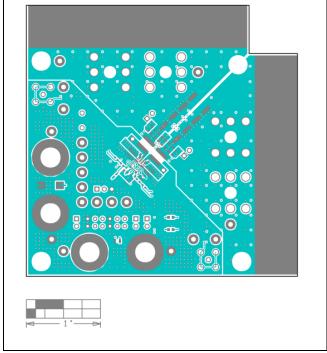
MAX20808 EV Kit PCB Layout



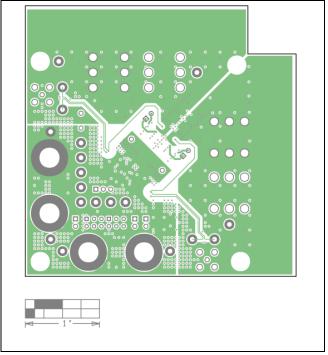
MAX20808 EV Kit Component Placement Guide—Top Silkscreen



MAX20808 EV Kit PCB Layout—Layer 2

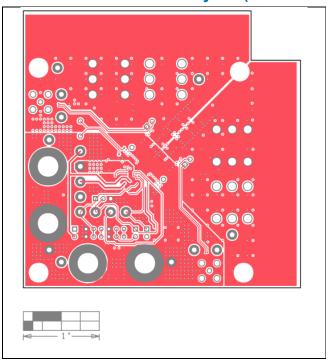


MAX20808 EV Kit PCB Layout—Top

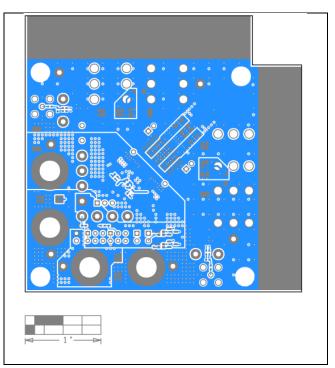


MAX20808 EV Kit PCB Layout—Layer 3

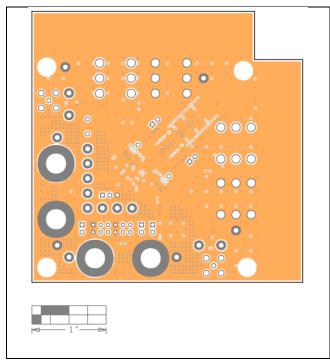
MAX20808 EV Kit PCB Layout (continued)



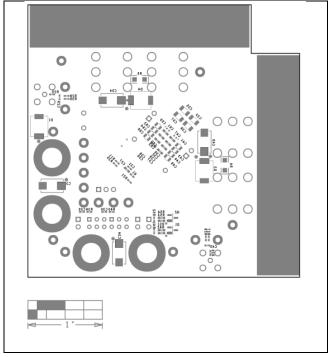
MAX20808 EV Kit PCB Layout—Layer 4



MAX20808 EV Kit PCB Layout—Bottom



MAX20808 EV Kit PCB Layout—Layer 5



MAX20808 EV Kit Component Placement Guide—Bottom Silkscreen

MAX20808 Evaluation Kit

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/21	Initial release	_
1	2/24	Added MAX20808T	1, 3, 4, 8

